

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	29	((156/345 or 118/715) .cc1s.) and splash (( "3834083" ) or ("4113492") or ("4393807") or ("4510176") or ("4518678") or ("4576796") or ("4611553") or ("4668334") or ("4685975") or ("4732785") or ("4790262") or ("4838979") or ("4886728") or ("4899685") or ("5013586") or ("5103102") or ("5151219") or ("5238713") or ("5279926") or ("5289222") or ("5294257") or ("5358740") or ("5362608") or ("5378511") or ("5444921") or ("5474807") or ("5580607") or ("5705223") or ("6062288") .PN.	USPAT	2001/01/19 08:27
2	I S&R	L2	29	2 and (splash\$3)	USPAT	2001/01/19 08:40
3	BRS	L3	9		USPAT	2001/01/19 08:41

Hits	Search Text	DBS	Time Stamp
3834	(156/345 or 118/715) .cc1s.	USPAT	2001/01/04 19:09
239	((156/345 or 118/715) .cc1s.) and suction\$3	USPAT	2001/01/19 08:27
63	((156/345 or 118/715) .cc1s.) and plunger	USPAT	2001/01/04 19:10
2338	((156/345 or 118/715) .cc1s.) and suction\$3 or ((156/345 or 118/715) .cc1s.) and (plunger or vacuum)	USPAT	2001/01/19 08:40
201787	(suction\$3 or vacuum or plung\$3) and (rotate\$3 spin\$3)	USPAT	2001/01/08 10:57
22400	((suction\$3 or vacuum or plung\$3) and (rotate\$3 spin\$3)) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER)	USPAT	2001/01/08 11:02
18224	(( (suction\$3 or vacuum or plung\$3) and (rotate\$3 spin\$3) ) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER) ) AND (RESIST ETCH\$3 COAT\$ DEPOSIT\$3) )	USPAT	2001/01/08 11:05
2454	(( (suction\$3 or vacuum or plung\$3) and (rotate\$3 spin\$3) ) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER) ) AND (RESIST ETCH\$3 COAT\$ DEPOSIT\$3) ) AND ((156/345.CCLS. AND 427/\$.CCLS. OR 438/\$.CCLS. )	USPAT	2001/01/08 11:07
293	((156/345 or 118/715) .cc1s.) and suction\$3 or ((156/345 or 118/715) .cc1s.) and plunger	USPAT	2001/01/08 11:11
239	((156/345 or 118/715) .cc1s.) and suction\$3 or ((156/345 or 118/715) .cc1s.) and plunger) AND (SPINNER OR "SPIN CHUCK")	USPAT	2001/01/08 11:12